

## P-Channel Enhancement Mode MOSFET

TDM3421

**DESCRIPTION**

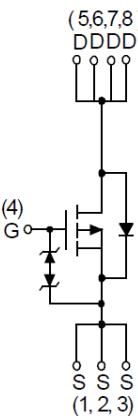
The TDM3421 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

**GENERAL FEATURES**

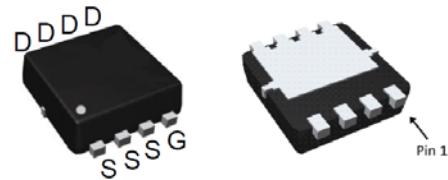
- RDS(ON) < 32mΩ @ VGS=-4.5V
- RDS(ON) < 19mΩ @ VGS=-10V
- Reliable and Rugged
- ESD protection pass 2KV
- Lead free product is available
- PPAK-3\*3-8 Package

**Application**

- PWM applications
- Load switch
- Power management



P-Channel MOSFET



PPAK-3\*3-8

**ABSOLUTE MAXIMUM RATINGS**<sub>(TA=25°C unless otherwise noted)</sub>

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	-30	V
Gate-Source Voltage	V <sub>GS</sub>	<u>±25</u>	V
Diode Continuous Forward Current	I <sub>S</sub> (T <sub>c</sub> =25°C)	-16	A
Pulsed Drain Current	I <sub>DM</sub> (T <sub>c</sub> =25°C)	-70	A
Continuous Drain Current	I <sub>D</sub> (T <sub>c</sub> =25°C)	-32	A
	I <sub>D</sub> (T <sub>c</sub> =100°C)	-20	A
Maximum Power Dissipation	P <sub>D</sub> (T <sub>c</sub> =25°C)	29.8	W
	P <sub>D</sub> (T <sub>c</sub> =100°C)	11.9	W
Continuous Drain Current	I <sub>D</sub> (T <sub>A</sub> =25°C)	-10.5	A
	I <sub>D</sub> (T <sub>A</sub> =70°C)	-8.4	A
Maximum Power Dissipation (note1)	P <sub>D</sub> (T <sub>A</sub> =25°C)	3.1	W
	P <sub>D</sub> (T <sub>A</sub> =70°C)	2	W
Maximum Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	°C
Thermal Resistance-Junction to Ambient (note1)	R <sub>θJA</sub> (t≤10s)	40	°C/W
	R <sub>θJA</sub> (Steady State)	75	°C/W

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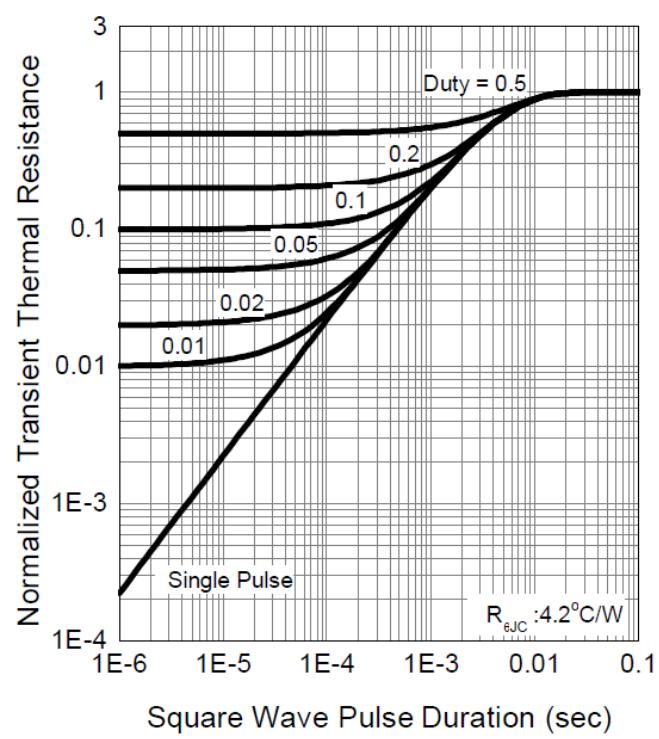
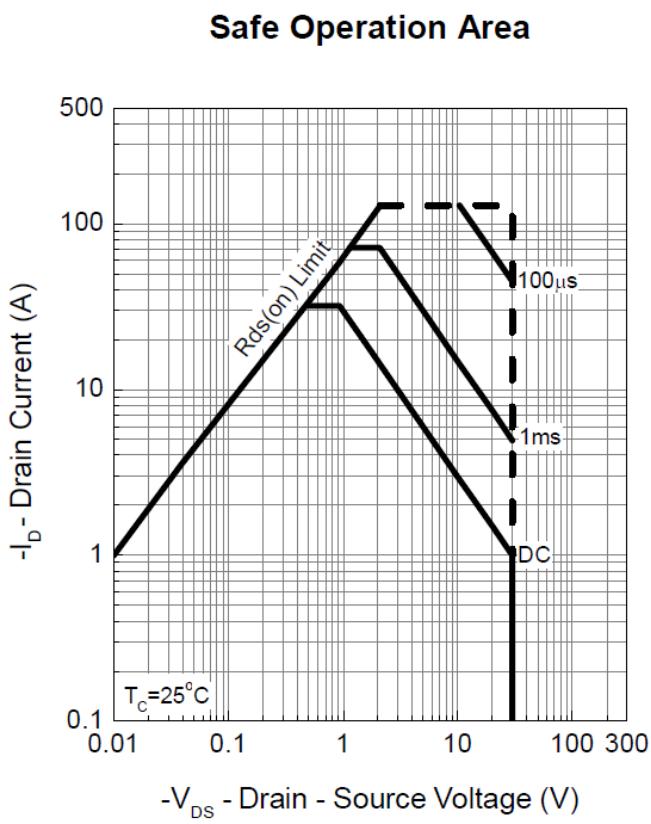
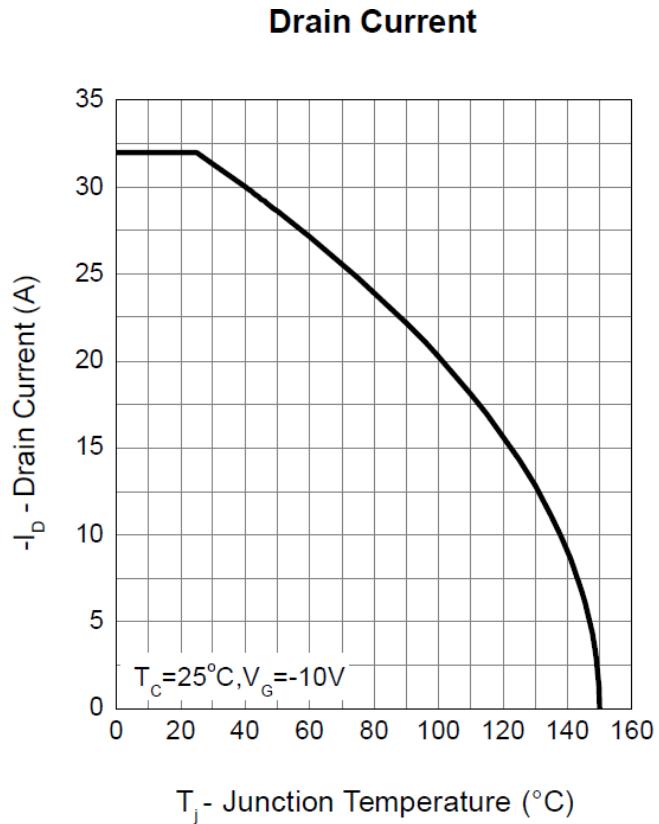
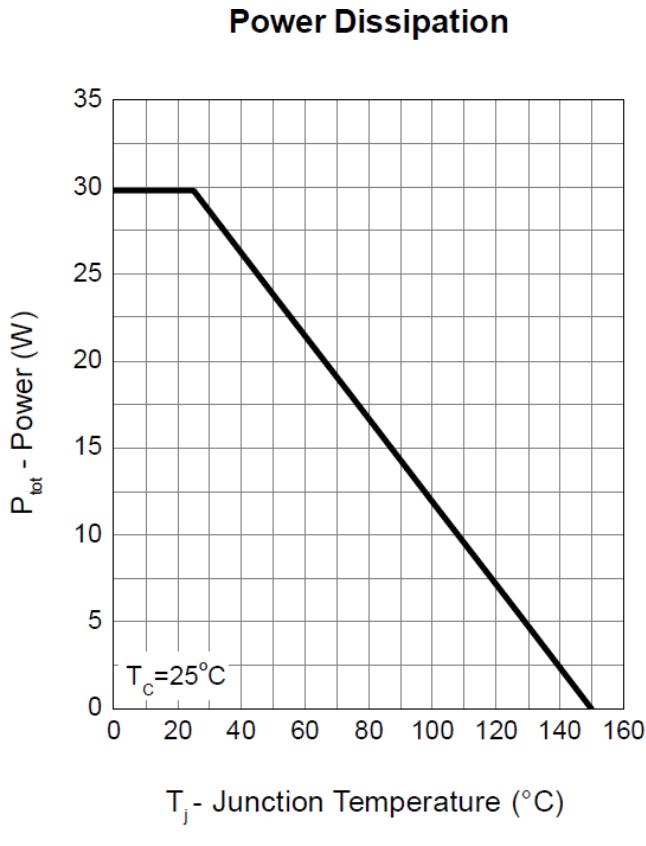
**ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>STATIC CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$	-30	-	-	V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=-24, \text{V}_{\text{GS}}=0\text{V}$	-	-	-1	$\mu\text{A}$
Gate-Body Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm25\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm10$	$\mu\text{A}$
<b>ON CHARACTERISTICS (Note 3)</b>						
Gate Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=-250\mu\text{A}$	-1.3	-1.8	-2.3	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS(ON)}}$	$\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_{\text{DS}}=-8.2\text{A}$	-	25	32	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-10\text{V}, \text{I}_{\text{DS}}=-10.5\text{A}$	-	16	19	$\text{m}\Omega$
<b>DYNAMIC CHARACTERISTICS (Note 4)</b>						
Gate Resistance	$\text{R}_g$	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=0\text{V}, \text{F}=1\text{MHz}$	-	4	-	$\Omega$
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=-15\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{F}=1.0\text{MHz}$	-	999	-	PF
Output Capacitance	$\text{C}_{\text{oss}}$		-	220	-	PF
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		-	170	-	PF
<b>SWITCHING CHARACTERISTICS (Note 4)</b>						
Turn-on Delay Time	$\text{t}_{\text{d(on)}}$	$\text{V}_{\text{DD}}=-15\text{V}, \text{R}_L=15\Omega, \text{V}_{\text{GEN}}=-10\text{V}, \text{R}_g=6\Omega, \text{I}_{\text{DS}}=-1\text{A}$	-	11.2	-	ns
Turn-on Rise Time	$\text{t}_r$		-	10.6	-	ns
Turn-Off Delay Time	$\text{t}_{\text{d(off)}}$		-	37	-	ns
Turn-Off Fall Time	$\text{t}_f$		-	50	-	ns
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=-15\text{V}, \text{I}_{\text{DS}}=-10.5\text{A}, \text{V}_{\text{GS}}=-10\text{V}$	-	20	-	nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$		-	1.1	-	nC
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		-	7.7	-	nC
Body Diode Reverse Recovery Time	$\text{T}_{\text{rr}}$	$\text{I}_{\text{DS}}=-10.5\text{A}, \text{dI}/\text{dt}=100\text{A}/\mu\text{s}$	-	18	-	ns
Body Diode Reverse Recovery Charge	$\text{Q}_{\text{rr}}$		-	9	-	nC
<b>DRAIN-SOURCE DIODE CHARACTERISTICS</b>						
Diode Forward Voltage (Note 3)	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_{\text{SD}}=-1\text{A}$	-	-0.7	-1	V

## NOTES:

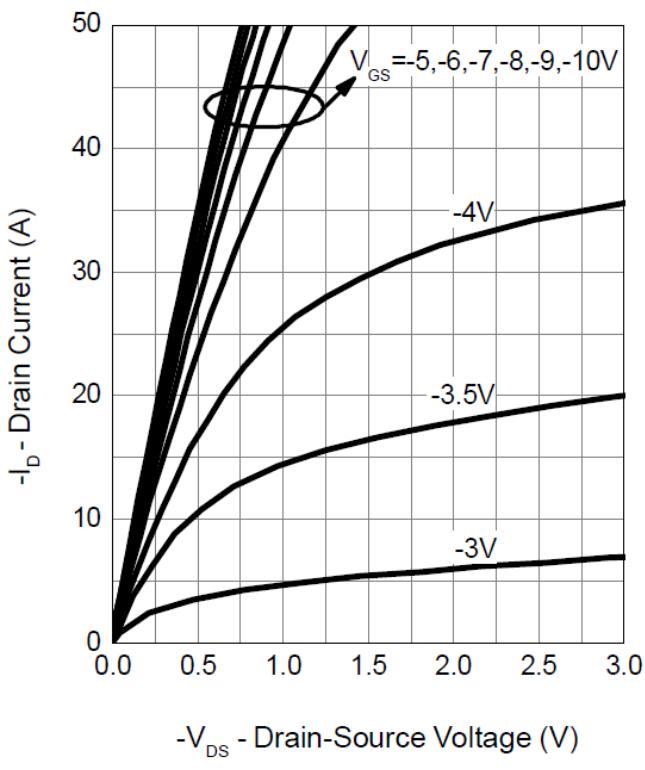
1. Surface Mounted on 1in<sup>2</sup> pad area,  $t \leq 10\text{sec}$ .  $R_{\theta_{JA}}$  steady state  $t = 999\text{s}$ .
2. The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})} = 150^\circ\text{C}$ , and it is useful for reducing junction-to-case thermal resistance ( $R_{\theta_{JC}}$ ) when additional heat sink is used.
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production testing

## Typical Operating Characteristics



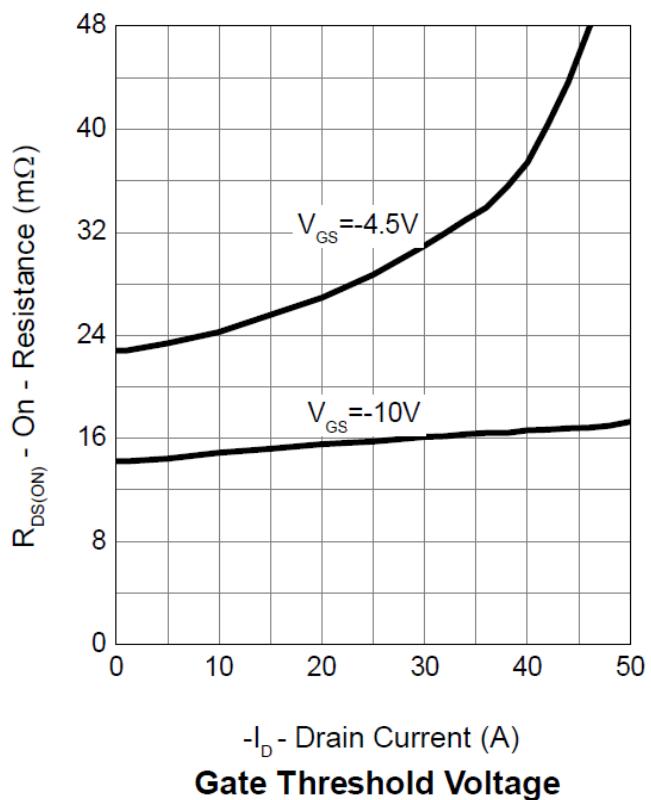
## Typical Operating Characteristics(Cont.)

Output Characteristics

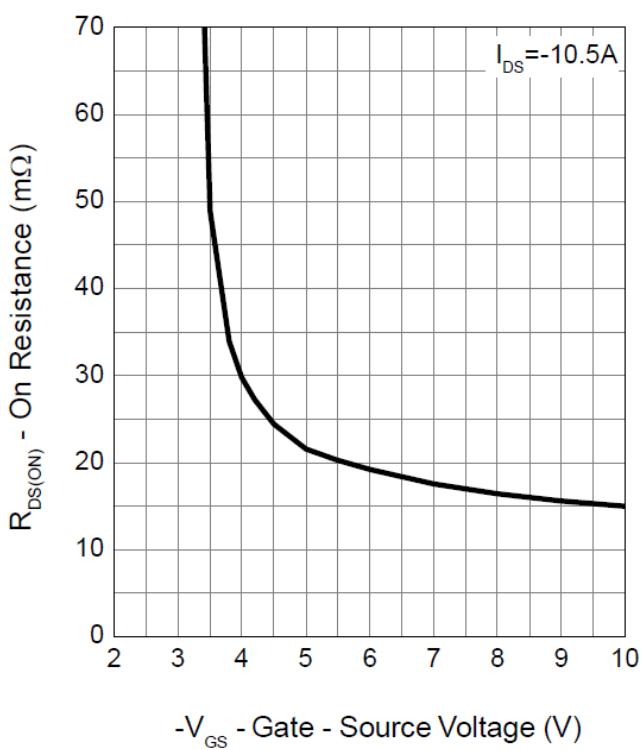
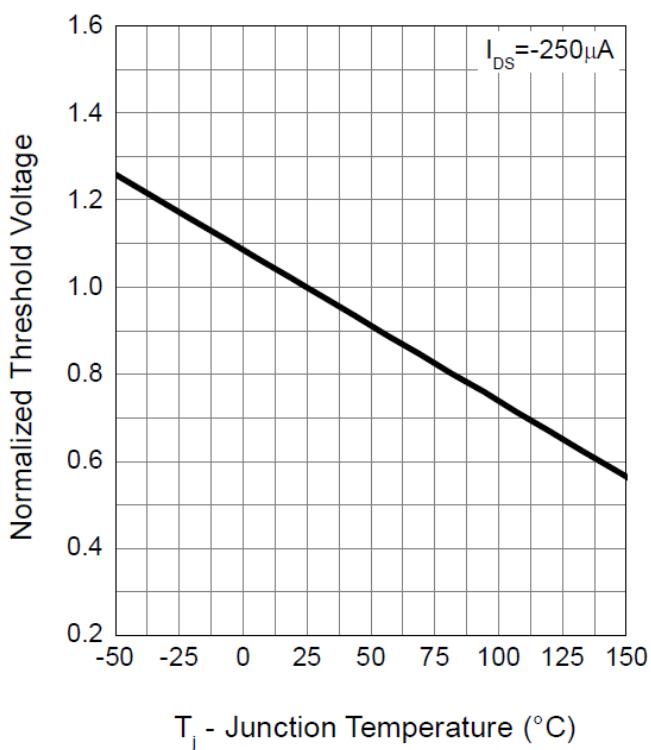
 $-V_{DS}$  - Drain-Source Voltage (V)

Gate-Source On Resistance

Drain-Source On Resistance

 $-I_D$  - Drain Current (A)

Gate Threshold Voltage

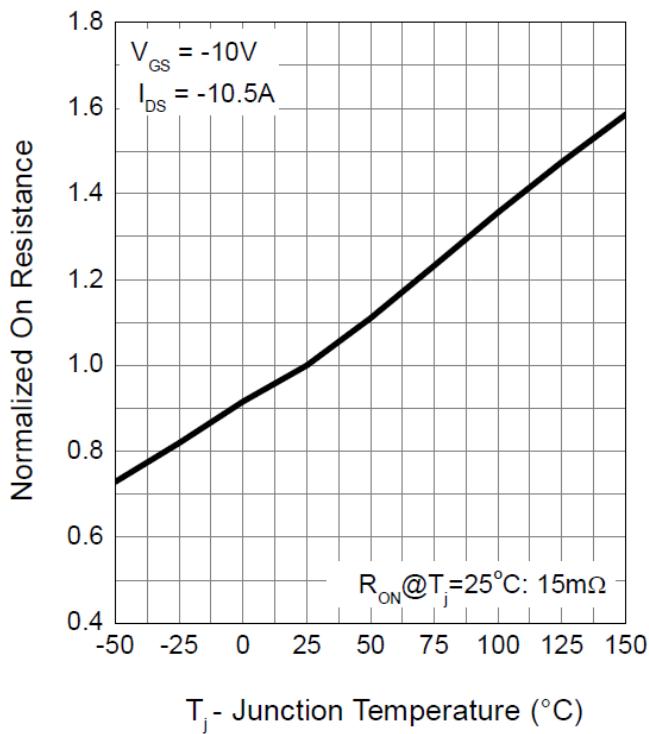
 $-V_{GS}$  - Gate - Source Voltage (V) $T_j$  - Junction Temperature (°C)

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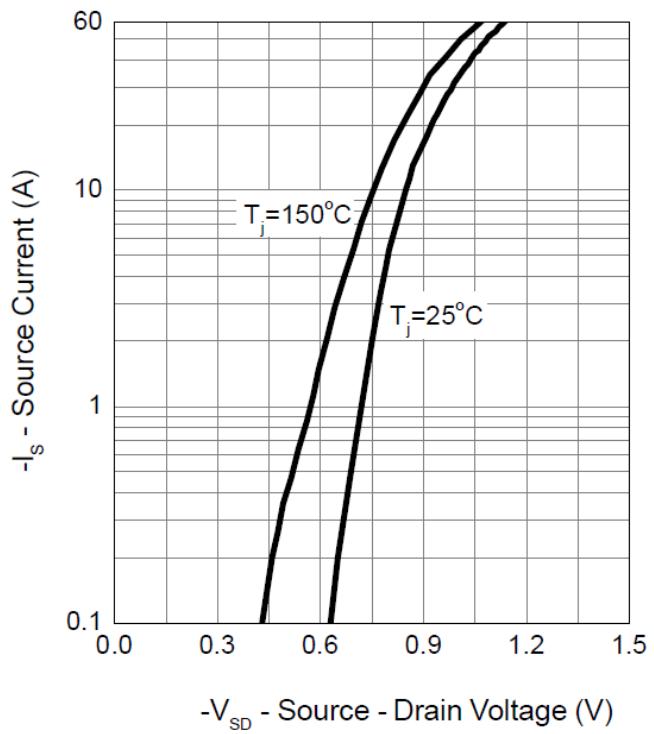
TDM3421

## Typical Operating Characteristics (Cont.)

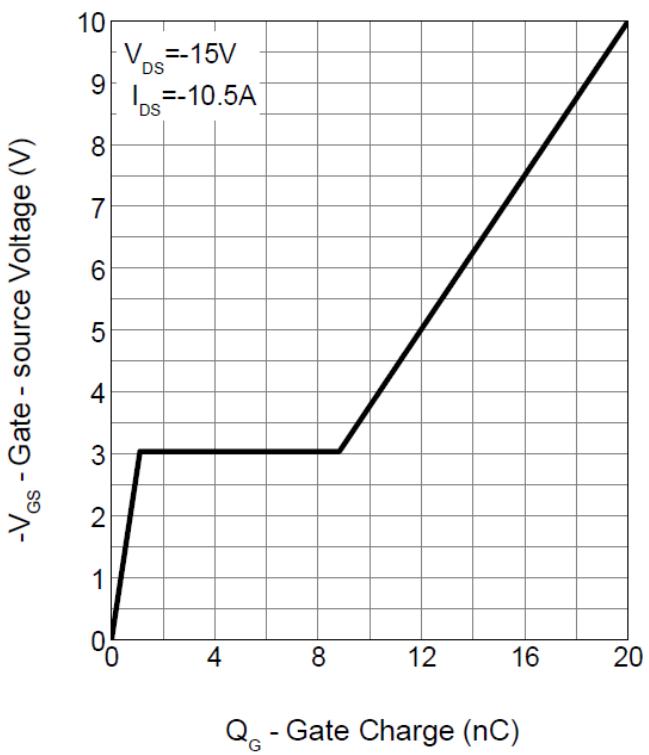
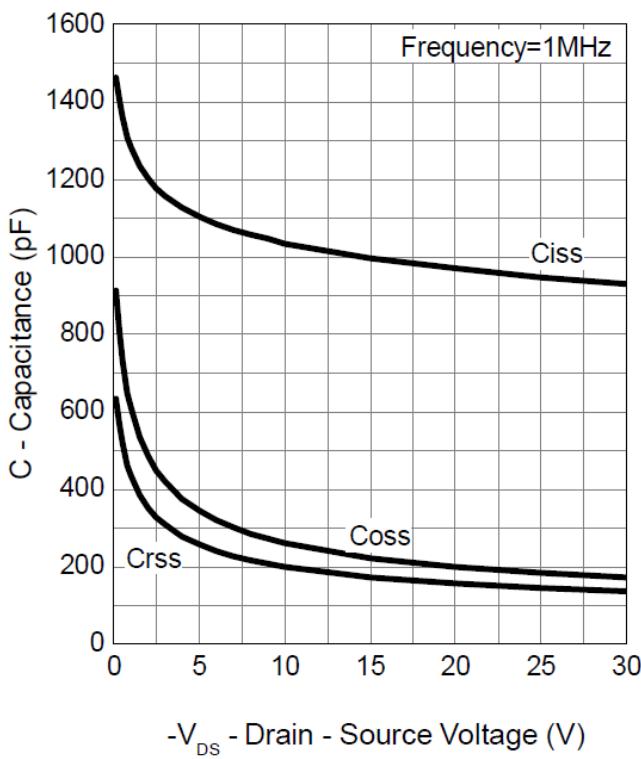
## Drain-Source On Resistance



## Source-Drain Diode Forward



## Capacitance

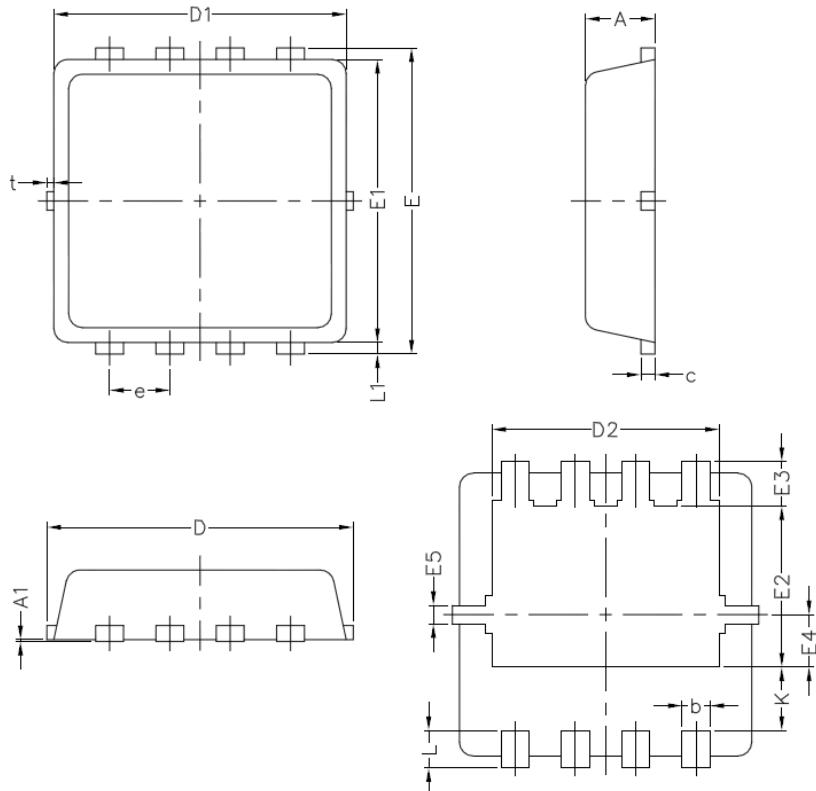


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## Package Information

PPAK-3\*3-8 Package



Symbol	PPAK-3*3-8(mm)		
	Min	Nom	Max
A	0.70	0.75	0.85
A1	/	/	0.05
b	0.20	0.30	0.40
c	0.10	0.152	0.25
D	3.15	3.3	3.45
D1	3.00	3.15	3.30
D2	2.25	2.45	2.65
E	3.15	3.30	3.45
E1	2.90	3.05	3.20
E2	1.54	1.74	1.94
E3	0.28	0.48	0.68
E4	0.37	0.57	0.77
E5	0.10	0.20	0.30
e	0.60	0.65	0.70
K	0.49	0.69	0.89
L	0.30	0.40	0.50
L1	0.06	0.125	0.20
t	/	/	0.13

Design Notes

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